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Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Not For New Designs
Core Processor	R8C
Core Size	16-Bit
Speed	16MHz
Connectivity	I ² C, LINbus, SIO, SSU, UART/USART
Peripherals	POR, Voltage Detect, WDT
Number of I/O	41
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f21206kfp-u1

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R8C/20 Group, R8C/21 Group RENESAS MCU

REJ03B0120-0200 Rev.2.00 Aug 27, 2008

1. Overview

This MCU is built using the high-performance silicon gate CMOS process using the R8C CPU core and is packaged in a 48-pin plastic molded LQFP. This MCU operates using sophisticated instructions featuring a high level of instruction efficiency. With 1 Mbyte of address space, it is capable of executing instructions at high speed. This Furthermore, the data flash (1 KB x 2 blocks) is embedded in the R8C/21 Group.

The difference between R8C/20 and R8C/21 Groups is only the existence of the data flash. Their peripheral functions are the same.

1.1 Applications

Automotive, etc.



Functions and Specifications for R8C/21 Group Table 1.2

1	Item	Specification
CPU	Number of fundamental instructions	·
01 0	Minimum instruction execution time	50 ns (f(XIN) = 20 MHz, VCC = 3.0 to 5.5 V)
	Willimian instruction execution time	100 ns (f(XIN) = 10 MHz, VCC = 2.7 to 5.5 V)
	Operating mode	Single-chip
	Address space	1 Mbyte
	Memory capacity	Refer to Table 1.4 Product Information for R8C/21 Group
Peripheral	Ports	I/O ports: 41 pins, Input port: 3 pins
Function	Timers	Timer RA: 8 bits x 1 channel,
		Timer RB: 8 bits x 1 channel
		(Each timer equipped with 8-bit prescaler)
		Timer RD: 16 bits x 2 channel
		(Circuits of input capture and output compare)
		Timer RE: With compare match function
	Serial interface	1 channel (UART0)
		Clock synchronous I/O, UART
		1 channel (UART1)
		UART
	Clock synchronous serial interface	1 channel
		I ² C bus interface ⁽²⁾ , Clock synchronous serial I/O with chip
		select
	LIN module	Hardware LIN: 1 channel
		(Timer RA, UART0)
	A/D converter	10-bit A/D converter: 1 circuit, 12 channels
	Watchdog timer	15 bits x 1 channel (with prescaler)
		Reset start selectable
	Interrupts	Internal: 11 sources, External: 5 sources, Software: 4 sources, Priority level: 7 levels
	Clock generation circuits	2 circuits
		XIN clock generation circuit (with on-chip feedback resistor)
		On-chip oscillator (high speed, low speed)
		High-speed on-chip oscillator has frequency adjustment function.
	Oscillation stop detection	Stop detection of XIN clock oscillation
	function	Stop detection of Any clock oscillation
	Voltage detection circuit	On-chip
	Power-on reset circuit include	On-chip
Electric	Supply voltage	VCC = 3.0 to 5.5 V (f(XIN) = 20 MHz)(J version)
Characteristics	Cupply voltage	VCC = 3.0 to 5.5 V (f(XIN) = 26 MHz)(6 Version)
Ondraotonolio		VCC = 2.7 to 5.5 V (f(XIN) = 10 MHz)
	Current consumption	Typ. 11.0 mA (VCC = 5 V, f(XIN) = 20 MHz, High-speed on-
	·	chip oscillator stopping)
		Typ. 5.3 mA (VCC = 5 V, f(XIN) = 10 MHz, High-speed on-chip
		oscillator stopping)
Flash Memory	Programming and erasure voltage	VCC = 2.7 to 5.5 V
	Programming and erasure	10,000 times (data flash)
	endurance	1,000 times (program ROM)
Operating Ambi	ent Temperature	-40 to 85°C
		-40 to 125°C (option ⁽¹⁾)
Package		48-pin mold-plastic LQFP
<u> </u>		<u> </u>

- When using options, be sure to inquire about the specification.
 I²C bus is a registered trademark of Koninklijke Philips Electronics N.V.



1.5 Pin Assignments

Figure 1.4 shows Pin Assignments (Top View).

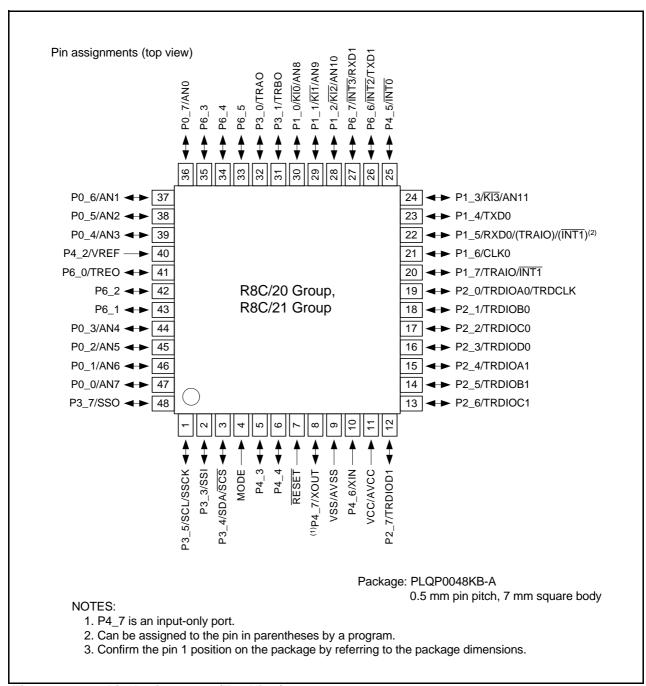


Figure 1.4 Pin Assignments (Top View)

3.2 R8C/21 Group

Figure 3.2 shows a Memory Map of R8C/21 Group. The R8C/21 Group has 1 Mbyte of address space from address 00000h to FFFFFh.

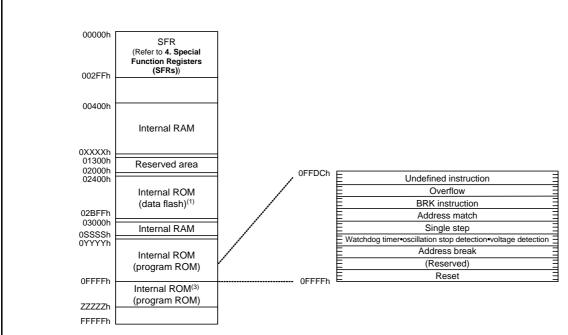
The internal ROM (program ROM) is allocated lower addresses, beginning with address 0FFFFh. For example, a 48-Kbyte internal ROM is allocated addresses 04000h to 0FFFFh.

The fixed interrupt vector table is allocated addresses 0FFDCh to 0FFFFh. They store the starting address of each interrupt routine.

The internal ROM (data flash) is allocated addresses 02400h to 02BFFh.

The internal RAM is allocated higher addresses, beginning with address 00400h. For example, a 2.5-Kbyte internal RAM is allocated addresses 00400h to 00DFFh. The internal RAM is used not only for storing data but also for calling subroutines and as stacks when interrupt requests are acknowledged.

Special function registers (SFR) are allocated addresses 00000h to 002FFh. The peripheral function control registers are allocated them. All addresses within the SFR, which have nothing allocated are reserved for future use and cannot be accessed by users.



NOTES:

- 1. Data flash block A (1 Kbyte) and B (1 Kbyte) are shown.
- 2. The blank regions are reserved. Do not access locations in these regions
- Do not use addresses 20000h to 23FFFh because these areas are used for the emulator debugger. Refer to 23. Notes on Emulator Debugger of Hardware Manual.

Dord M. selver		Internal ROM	1		Internal RAM	1
Part Number	Size	Address 0YYYYh	Address ZZZZZh	Size	Address 0XXXXh	Address 0SSSSh
R5F21216JFP, R5F21216KFP	32 Kbytes	08000h	-	2 Kbytes	00BFFh	-
R5F21217JFP, R5F21217KFP	48 Kbytes	04000h	-	2.5 Kbytes	00DFFh	-
R5F21218JFP, R5F21218KFP	64 Kbytes	04000h	13FFFh	3 Kbytes	00FFFh	-
R5F2121AJFP, R5F2121AKFP	96 Kbytes	04000h	1BFFFh	5 Kbytes	00FFFh	037FFh
R5F2121CJFP, R5F2121CKFP	128 Kbytes	04000h	23FFFh	6 Kbytes	00FFFh	03BFFh

Figure 3.2 Memory Map of R8C/21 Group

Page 14 of 41

0100X001b(4)

VW2C

Special Function Registers (SFRs) 4.

An SFR (special function register) is a control register for a peripheral function. Table 4.1 to Table 4.6 list the SFR Information.

SFR Information (1)⁽¹⁾ Table 4.1

Address	Register	Symbol	After reset
0000h	· ·		
0001h			
0002h			
0003h			
0004h	Processor Mode Register 0	PM0	00h
0005h	Processor Mode Register 1	PM1	00h
0006h	System Clock Control Register 0	CM0	01101000b
0007h	System Clock Control Register 1	CM1	00100000b
0008h			
0009h			
000Ah	Protect Register	PRCR	00h
000Bh			
000Ch	Oscillation Stop Detection Register	OCD	00000100b
000Dh	Watchdog Timer Reset Register	WDTR	XXh
000Eh	Watchdog Timer Start Register	WDTS	XXh
000Fh	Watchdog Timer Control Register	WDC	00X11111b
0010h	Address Match Interrupt Register 0	RMAD0	00h
0011h]		00h
0012h			00h
0013h	Address Match Interrupt Enable Register	AIER	00h
0014h	Address Match Interrupt Register 1	RMAD1	00h
0015h			00h
0016h			00h
0017h			
0018h			
0019h			
001Ah			
001Bh			
001Ch	Count Source Protect Mode Register	CSPR	00h 10000000b ⁽⁸⁾
001Dh			
001Eh			
001Fh			
0020h			
0021h			
0022h			
0023h	High-Speed On-Chip Oscillator Control Register 0	FRA0	00h
0024h	High-Speed On-Chip Oscillator Control Register 1	FRA1	When shipping
0025h	High-Speed On-Chip Oscillator Control Register 2	FRA2	00h
0026h			
0030h			
0031h	Voltage Detection Register 1 ⁽²⁾	VCA1	00001000b
0032h	Voltage Detection Register 2 ⁽⁶⁾	VCA2	00h ⁽³⁾
			01000000b ⁽⁴⁾
0033h			
0034h			
0035h			
0036h	Voltage Monitor 1 Circuit Control Register ⁽⁷⁾	VW1C	0000X000b ⁽³⁾
	1 3		1

X: Undefined

NOTES:

0037h

0038h 0039h 003Fh

- 1. The blank regions are reserved. Do not access locations in these regions.
- 2. Software reset, watchdog timer reset, and voltage monitor 2 reset do not affect this register.
- 3. The LVD0ON bit in the OFS register is set to 1.

Voltage Monitor 2 Circuit Control Register(5)

- 4. Power-on reset, voltage monitor 1 reset or the LVD0ON bit in the OFS register is set to 0.
- 5. Software reset, watchdog timer reset, and voltage monitor 2 reset do not affect b2 and b3.
- 6. Software reset, watchdog timer reset, and voltage monitor 2 reset do not affect b7.
- 7. Software reset, the watchdog timer rest, and the voltage monitor 2 reset do not affect other than the b0 and b6.
- 8. The CSPROINI bit in the OFS register is 0.



SFR Information (2)⁽¹⁾ Table 4.2

	. ,		1 46
Address	Register	Symbol	After reset
0040h			
0041h			
0042h			
0043h			
0044h			
0045h			
0046h			
0047h			
0048h	Timer RD0 Interrupt Control Register	TRD0IC	XXXXX000b
0049h	Timer RD1 Interrupt Control Register	TRD1IC	XXXXX000b
	Timer KDT Interrupt Control Register		
004Ah	Timer RE Interrupt Control Register	TREIC	XXXXX000b
004Bh			
004Ch			
004Dh	Key Input Interrupt Control Register	KUPIC	XXXXX000b
004Eh	A/D Conversion Interrupt Control Register	ADIC	XXXXX000b
004Fh	SSU Interrupt Control Register/IIC Bus Interrupt Control Register ⁽²⁾	SSUIC/IICIC	XXXXX000b
	550 Interrupt Control Register/IIC Bus Interrupt Control Register(2)	33010/11010	**************************************
0050h			
0051h	UART0 Transmit Interrupt Control Register	S0TIC	XXXXX000b
0052h	UART0 Receive Interrupt Control Register	SORIC	XXXXX000b
0053h	UART1 Transmit Interrupt Control Register	S1TIC	XXXXX000b
0053h	UART1 Receive Interrupt Control Register	S1RIC	XXXXX000b
0055h	INT2 Interrupt Control Register	INT2IC	XX00X000b
0056h	Timer RA Interrupt Control Register	TRAIC	XXXXX000b
0057h			
0058h	Timer RB Interrupt Control Register	TRBIC	XXXXX000b
0059h	INT1 Interrupt Control Register	INT1IC	XX00X000b
005Ah	INT3 Interrupt Control Register	INT3IC	XX00X000b
005Bh			
005Ch			
005Dh	INT0 Interrupt Control Register	INTOIC	XX00X000b
005Eh	The street april of the origination		7.5.1007.10002
005Fh			
0060h			
0061h			
0062h			
0063h			
0064h			
0065h			
0066h			
0067h			
0068h			
0069h			
006Ah			
006Bh			
006Ch			
006Dh			
006Eh			+
006Fh			
0070h			
0071h			
0072h			
0072h			
0074h			
0075h			
0075h 0076h			
0076h 0077h			
0076h 0077h 0078h			
0076h 0077h 0078h 0079h			
0076h 0077h 0078h			
0076h 0077h 0078h 0079h			
0076h 0077h 0078h 0079h 007Ah			
0076h 0077h 0078h 0079h 007Ah 007Bh			
0076h 0077h 0078h 0079h 007Ah 007Bh 007Ch			
0076h 0077h 0078h 0079h 007Ah 007Bh			

- The blank regions are reserved. Do not access locations in these regions.
 Selected by the IICSEL bit in the PMR register.

SFR Information (3)⁽¹⁾ Table 4.3

Address	Register	Symbol	After reset
0080h		-,	
0081h			
0082h			
0083h			
0084h			
0085h			
0086h			
0087h			
0088h			
0089h			
008Ah			
008Bh			
008Ch			
008Dh			
008Eh			
008Fh			
0090h			
0091h			
0092h			
0093h			
0094h 0095h			
0095h 0096h			1
0096h			
009711 0098h			
0099h			
0099h			
009Bh			
009Ch			
009Dh			
009Eh			
009Fh			
00A0h	UART0 Transmit/Receive Mode Register	U0MR	00h
00A1h	UARTO Bit Rate Register	U0BRG	XXh
00A2h	UART0 Transmit Buffer Register	U0TB	XXh
00A3h			XXh
00A4h	UART0 Transmit/Receive Control Register 0	U0C0	00001000b
00A5h	UART0 Transmit/Receive Control Register 1	U0C1	00000010b
00A6h	UART0 Receive Buffer Register	U0RB	XXh
00A7h			XXh
00A8h	UART1 Transmit/Receive Mode Register	U1MR	00h
00A9h	UART1 Bit Rate Register	U1BRG	XXh
00AAh	UART1 Transmit Buffer Register	U1TB	XXh
00ABh	LIADTA Teconomit/December Construit Decisions Co	114.00	XXh
00ACh 00ADh	UART1 Transmit/Receive Control Register 0 UART1 Transmit/Receive Control Register 1	U1C0 U1C1	00001000b 00000010b
00ADh 00AEh	UART1 Transmit/Receive Control Register 1 UART1 Receive Buffer Register	U1RB	XXh
00AEn	OARTH RECEIVE DUILE REGISTER	JIND	XXh
00B0h			7931
00B0H			
00B1H			
00B3h			
00B4h			
00B5h			
00B6h			
00B7h			
00B8h	SS Control Register H/IIC Bus Control Register 1 ⁽²⁾	SSCRH/ICCR1	00h
00B9h	SS Control Register L/IIC Bus Control Register 2 ⁽²⁾	SSCRL/ICCR2	01111101b
00BAh	SS Mode Register/IIC Bus Mode Register 1(2)	SSMR/ICMR	00011000b
00BBh	SS Enable Register/IIC Bus Interrupt Enable Register ⁽²⁾	SSER/ICIER	00h
00BCh	SS Status Register/IIC Bus Status Register ⁽²⁾	SSSR/ICSR	00h/0000X000b
00BDh	SS Mode Register 2/Slave Address Register ⁽²⁾	SSMR2/SAR	00h
00BEh	SS Transmit Data Register/IIC Bus Transmit Data Register ⁽²⁾	SSTDR/ICDRT	FFh
00BFh	SS Receive Data Register/IIC Bus Receive Data Register ⁽²⁾	SSRDR/ICDRR	FFh
	Too house of bala hogistoning bala houself bala hogiston	1 - 2	T

- The blank regions are reserved. Do not access locations in these regions.
 Selected by the IICSEL bit in the PMR register.

SFR Information (5)⁽¹⁾ Table 4.5

Address	Register	Symbol	After reset
0100h	Timer RA Control Register	TRACR	00h
0101h	Timer RA I/O Control Register	TRAIOC	00h
0102h	Timer RA Mode Register	TRAMR	00h
0103h	Timer RA Prescaler Register	TRAPRE	FFh
0104h	Timer RA Register	TRA	FFh
0105h	Ü		
0106h	LIN Control Register	LINCR	00h
0107h	LIN Status Register	LINST	00h
0108h	Timer RB Control Register	TRBCR	00h
0109h	Timer RB One-Shot Control Register	TRBOCR	00h
0103h	Timer RB I/O Control Register	TRBIOC	00h
010An	Timer RB Mode Register	TRBMR	00h
	Timer RB Prescaler Register		
010Ch		TRBPRE	FFh
010Dh	Timer RB Secondary Register	TRBSC	FFh
010Eh	Timer RB Primary	TRBPR	FFh
010Fh			
0110h			
0111h			
0112h			
0113h			
0114h			
0115h			
0116h			
0117h			<u> </u>
0117h	Timer RE Counter Data Register	TRESEC	00h
0119h	Timer RE Counter Data Register Timer RE Compare Data Register	TREMIN	00h
	Timer NE Compare Data Register	IREIVIIN	UUN
011Ah			
011Bh			
011Ch	Timer RE Control Register 1	TRECR1	00h
011Dh	Timer RE Control Register 2	TRECR2	00h
011Eh	Timer RE Count Source Select Register	TRECSR	00001000b
011Fh			
0120h			
0121h			
0122h			
0123h			
0124h			
0125h			
0125h			
0127h			
0128h			
0129h			
012Ah			
012Bh			
012Ch			
012Dh			
012Eh			
012Fh			
0130h			
0131h			
0131h			
0132h			+
0134h			
0135h			
0136h			
0137h	Timer RD Start Register	TRDSTR	11111100b
0138h	Timer RD Mode Register	TRDMR	00001110b
0139h	Timer RD PWM Mode Register	TRDPMR	10001000b
013Ah	Timer RD Function Control Register	TRDFCR	1000000b
013Bh	Timer RD Output Master Enable Register 1	TRDOER1	FFh
013Ch	Timer RD Output Master Enable Register 2	TRDOER2	01111111b
013Dh	Timer RD Output Control Register	TRDOCR	00h
0.0011			
013Eh	Timer RD Digital Filter Function Select Register 0	TRDDF0	00h

NOTE:

1. The blank regions are reserved. Do not access locations in these regions.

SFR Information (6)⁽¹⁾ Table 4.6

Address	Register	Symbol	After reset
0140h	Timer RD Control Register 0	TRDCR0	00h
0141h	Timer RD I/O Control Register A0	TRDIORA0	10001000b
0142h	Timer RD I/O Control Register C0	TRDIORC0	10001000b
0143h	Timer RD Status Register 0	TRDSR0	11100000b
0144h	Timer RD Interrupt Enable Register 0	TRDIER0	11100000b
0145h	Timer RD PWM Mode Output Level Control Register 0	TRDPOCR0	11111000b
0146h	Timer RD Counter 0	TRD0	00h
0147h	7		00h
0148h	Timer RD General Register A0	TRDGRA0	FFh
0149h	7		FFh
014Ah	Timer RD General Register B0	TRDGRB0	FFh
014Bh			FFh
014Ch	Timer RD General Register C0	TRDGRC0	FFh
014Dh			FFh
014Eh	Timer RD General Register D0	TRDGRD0	FFh
014Fh			FFh
0150h	Timer RD Control Register 1	TRDCR1	00h
0151h	Timer RD I/O Control Register A1	TRDIORA1	10001000b
0152h	Timer RD I/O Control Register C1	TRDIORC1	10001000b
0153h	Timer RD Status Register 1	TRDSR1	11000000b
0154h	Timer RD Interrupt Enable Register 1	TRDIER1	11100000b
0155h	Timer RD PWM Mode Output Level Control Register 1	TRDPOCR1	11111000b
0156h	Timer RD Counter 1	TRD1	00h
0157h			00h
0158h	Timer RD General Register A1	TRDGRA1	FFh
0159h	T	T000004	FFh
015Ah	Timer RD General Register B1	TRDGRB1	FFh
015Bh	T 000 10 11 01	TDD0004	FFh
015Ch	Timer RD General Register C1	TRDGRC1	FFh
015Dh 015Eh	Times DD Conord Deviator D4	TDDCDD4	FFh FFh
015En	Timer RD General Register D1	TRDGRD1	
UISFII			FFh
01B0h	1	T	
01B0H			
01B1II			
01B3h	Flash Memory Control Register 4	FMR4	01000000b
01B3h		1 WILLY	31000000
01B5h	Flash Memory Control Register 1	FMR1	1000000Xb
01B6h	and the state of t		
01B7h	Flash Memory Control Register 0	FMR0	00000001b
01B8h	, , , , , , , , , , , , , , , , ,		
01B9h			
01BAh			
01BBh			
01BCh			
01BDh			
01BEh			
01BFh			
	•	•	•
FFFFh	Option Function Select Register	OFS	(Note 2)

- The blank regions are reserved. Do not access locations in these regions.
 The OFS register cannot be changed by a program. Use a flash programmer to write to it.

Table 5.8 Power-on Reset Circuit, Voltage Monitor 1 Reset Circuit Electrical Characteristics(3)

Symbol	Parameter	Condition	Standard		Unit	
			Min.	Тур.	Max.	
Vpor1	Power-on reset valid voltage ⁽⁴⁾		-	_	0.1	V
Vpor2	Power-on reset or voltage monitor 1 valid voltage		0	_	Vdet1	V
trth	External power Vcc rise gradient	Vcc ≤ 3.6 V	20(2)	_	_	mV/msec
		Vcc > 3.6 V	20(2)	_	2,000	mV/msec

- 1. Topr = -40°C to 85°C (J version) / -40°C to 125°C (K version), unless otherwise specified.
- 2. This condition (the minimum value of external power Vcc rise gradient) does not apply if V_{por2} ≥ 1.0 V.
- 3. To use the power-on reset function, enable voltage monitor 1 reset by setting the LVD10N bit in the OFS register to 0, the VW1C0 and VW1C6 bits in the VW1C register to 1 respectively, and the VCA26 bit in the VCA2 register to 1.
- 4. tw(por1) indicates the duration the external power Vcc must be held below the effective voltage (Vpor1) to enable a power on reset. When turning on the power for the first time, maintain tw(por1) for 30s or more if $-20^{\circ}C \le Topr \le 125^{\circ}C$, maintain tw(por1) for 30s or more if $-20^{\circ}C \le Topr \le 125^{\circ}C$, maintain tw(por1) for 3,000s or more if -40° C \leq Topr $< -20^{\circ}$ C.

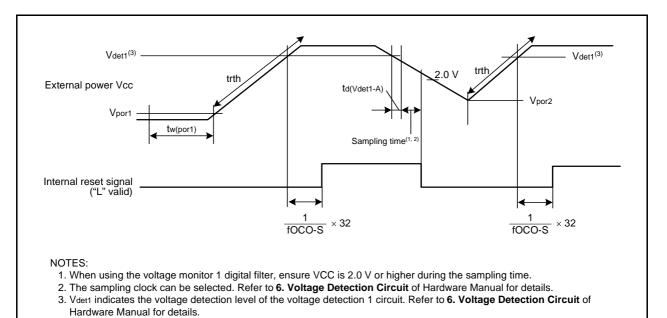


Figure 5.3 **Power-on Reset Circuit Electrical Characteristics**

Table 5.9 **High-Speed On-Chip Oscillator Circuit Electrical Characteristics**

Cymphol	Parameter	Condition	;	Unit		
Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
fOCO40M	High-speed on-chip oscillator frequency temperature • supply voltage dependence	Vcc = 4.75 V to 5.25 V, 0° C \leq Topr \leq 60° C ⁽²⁾	39.2	40	40.8	MHz
		Vcc = 3.0 V to 5.25 V, -20°C \leq Topr \leq 85°C ⁽²⁾	38.8	40	41.2	MHz
		Vcc = 3.0 V to 5.5 V, -40°C ≤ Topr ≤ 85°C(2) Vcc = 3.0 V to 5.5 V, -40°C ≤ Topr ≤ 125°C(2)	38.4	40	41.6	MHz
			38.0	40	42.0	MHz
		Vcc = 2.7 V to 5.5 V, -40°C \leq Topr \leq 125°C ⁽²⁾	37.6	40	42.4	MHz
_	The value of the FRA1 register when the reset is deasserted		08h	40	F7h	-
_	High-speed on-chip oscillator adjustment range	Adjust the FRA1 register to -1 bit (the value when the reset is deasserted)	-	+ 0.3	-	MHz
_	Oscillation stability time		-	10	100	μS
_	Self power consumption when high-speed on-chip oscillator oscillating	Vcc = 5.0 V, Topr = 25°C	-	600	-	μА

- 1. Vcc = 2.7 V to 5.5 V, Topr = -40 °C to 85 °C (J version) / -40 °C to 125 °C (K version), unless otherwise specified.
- 2. The standard value shows when the reset is deasserted for the FRA1 register.

Table 5.10 Low-Speed On-Chip Oscillator Circuit Electrical Characteristics

Svmbol	Parameter	Condition	,	Unit		
Symbol	Falantete	Condition	Min.	Тур.	Max.	Offic
fOCO-S	Low-speed on-chip oscillator frequency		40	125	250	kHz
_	Oscillation stability time		_	10	100	μS
-	Self power consumption when low-speed on-chip oscillator oscillating	Vcc = 5.0 V, Topr = 25°C	ı	15	II	μА

NOTE:

1. Vcc = 2.7 V to 5.5 V, Topr = -40°C to 85°C (J version) / -40°C to 125°C (K version), unless otherwise specified.

Table 5.11 Power Supply Circuit Timing Characteristics

Symbol	Parameter	Condition	Standard			Unit
Symbol	r alametel	Condition	Min.	Тур.	Max.	Offic
td(P-R)	Time for internal power supply stabilization during power-on ⁽²⁾		1	-	2000	μS
	power-one-					
td(R-S)	STOP exit time ⁽³⁾		-	-	150	μS

- 1. The measurement condition is Vcc = 2.7 to 5.5 V and Topr = -40°C to 85°C (J version) / -40°C to 125°C (K version), unless otherwise specified.
- 2. Waiting time until the internal power supply generation circuit stabilizes during power-on.
- 3. Time until CPU clock supply starts since the interrupt is acknowledged to exit stop mode.



Table 5.12 Timing Requirements of Clock Synchronous Serial I/O with Chip Select(1)

Symbol	Parameter		Conditions		l ladt		
	Parameter	Min.		Тур.	Max.	Unit	
tsucyc	SSCK clock cycle time	CK clock cycle time		4	-	=	tcyc(2)
tHI	SSCK clock "H" width			0.4	-	0.6	tsucyc
tLO	SSCK clock "L" width			0.4	-	0.6	tsucyc
trise	SSCK clock rising time Master Slave			-	=	1	tcyc(2)
				=	-	1	μS
tFALL	SSCK clock falling time	Master		-	=	1	tcyc(2)
		Slave		-	-	1	μS
tsu	SSO, SSI data input setup time			100	=	-	ns
tH	SSO, SSI data input hold time			1	=	=	tcyc(2)
tLEAD	SCS setup time	Slave		1tcyc + 50	-	-	ns
tLAG	SCS hold time	Slave		1tcyc + 50	_	_	ns
top	SSO, SSI data output delay time			=	=	1	tcyc(2)
tsa	SSI slave access time			_	=	1tcyc + 100	ns
tor	SSI slave out open time			_	-	1tcyc + 100	ns

- Vcc = 2.7 to 5.5 V, Vss = 0 V at Topr = -40 to 85°C (J version) / -40 to 125°C (K version), unless otherwise specified.
 1. tcyc = 1/f1(s)

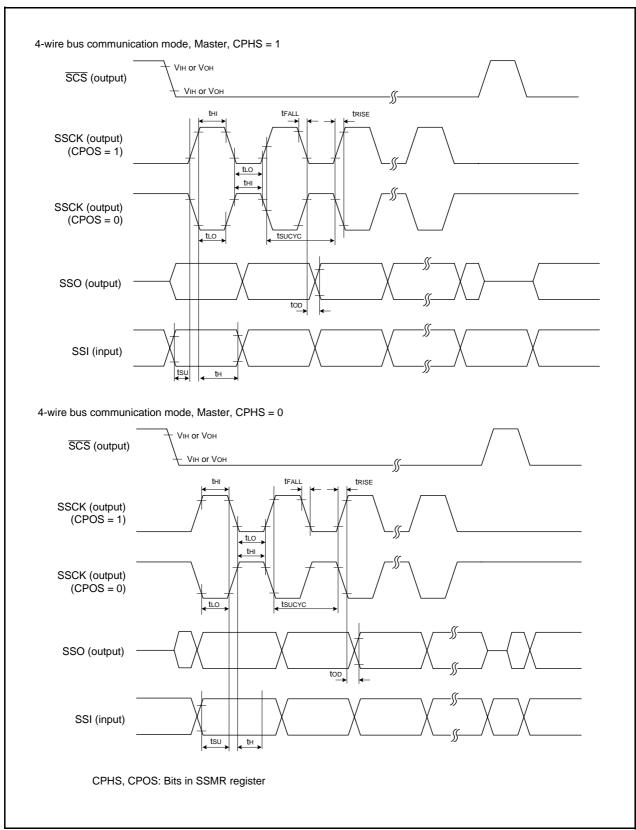


Figure 5.4 I/O Timing of Clock Synchronous Serial I/O with Chip Select (Master)

Table 5.13 Timing Requirements of I²C Bus Interface⁽¹⁾

Symbol	Parameter	Conditions		Llait		
	Parameter	Conditions	Min.	Тур. Мах.		Unit
tscl	SCL input cycle time		12tcyc + 600 ⁽²⁾	_	-	ns
tsclh	SCL input "H" width		3tcyc + 300 ⁽²⁾	-	-	ns
tscll	SCL input "L" width		5tcyc + 300 ⁽²⁾	_	-	ns
tsf	SCL, SDA input falling time		-	_	300	ns
tsp	SCL, SDA input spike pulse rejection time		=	-	1tcyc(2)	ns
tBUF	SDA input bus-free time		5tcyc(2)	-	=	ns
tstah	Start condition input hole time		3tcyc(2)	-	-	ns
tstas	Retransmit start condition input setup time		3tcyc(2)	-	-	ns
tstop	Stop condition input setup time		3tcyc(2)	-	-	ns
tsoas	Data input setup time		1tcyc + 20 ⁽²⁾	_	-	ns
tsdah	Data input hold time		0	-	-	ns

- 1. Vcc = 2.7 to 5.5 V, Vss = 0V at Topr = -40 to 85°C (J version) / -40 to 125°C (K version), unless otherwise specified.
 2. 1tcyc = 1/f1(s)

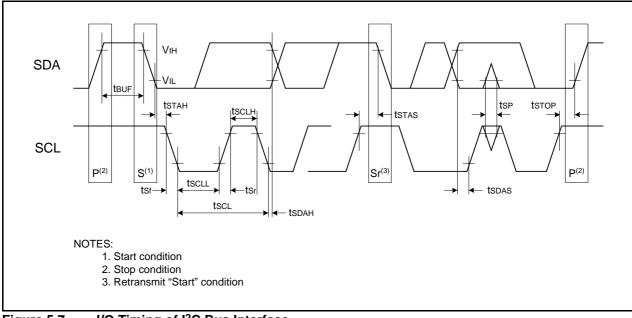


Figure 5.7 I/O Timing of I²C Bus Interface

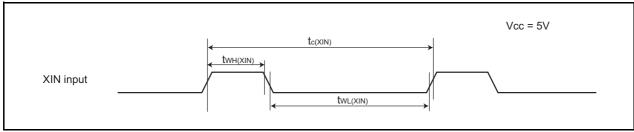
Electrical Characteristics (2) [Vcc = 5 V] **Table 5.15** (Topr = -40 to 85°C (J version) / -40 to 125°C (K version), Unless Otherwise Specified.)

Cumhal	Daramatar	Parameter Condition			Standard			
Symbol	Parameter		Condition	Min.	Тур.	Max.	Unit	
Icc	Power supply current (Vcc = 3.3 to 5.5 V) In single-chip mode, the output pins are	High-clock mode	XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	-	11.0	22.0	mA	
	open and other pins are Vss		XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	_	8.8	17.6	mA	
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	-	5.8	_	mA	
			XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8		5.0		mA	
			XIN = 16MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	=	3.8	-	mA	
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	-	2.8	_	mA	
		High-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator on fOCO = 10 MHz Low-speed on-chip oscillator on = 125 kHz No division	-	5.8	11.6	mA	
			XIN clock off High-speed on-chip oscillator on fOCO= 10 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	-	2.5		mA	
		Low-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8 FMR47 = 1	-	143	286	μА	
		Wait mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA20 = 0 VCA26 = VCA27 = 0	_	53	106	μА	
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA20 = 0 VCA26 = VCA27 = 0	_	38	76	μА	
		Stop mode Topr = 25°C	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA26 = VCA27 = 0	=	0.8	3.0	μА	
		Stop mode Topr = 85°C	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA26 = VCA27 = 0	_	1.2	-	μА	
		Stop mode Topr = 125°C	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA26 = VCA27 = 0	_	4.0	-	μА	

Timing Requirements (Unless Otherwise Specified: Vcc = 5 V, Vss = 0 V at Topr = 25°C) [Vcc = 5 V]

Table 5.16 XIN Input

Symbol	Parameter		Standard		
			Max.	Unit	
tc(XIN)	XIN input cycle time	50	=	ns	
twh(xin)	XIN input "H" width	25	=	ns	
tWL(XIN)	XIN input "L" width	25	-	ns	



XIN Input Timing Diagram when Vcc = 5 V Figure 5.8

Table 5.17 TRAIO Input

Symbol	Parameter		Standard		
			Max.	Unit	
tc(TRAIO)	TRAIO input cycle time	100	-	ns	
tWH(TRAIO)	TRAIO input "H" width	40	-	ns	
tWL(TRAIO)	TRAIO input "L" width	40	=	ns	

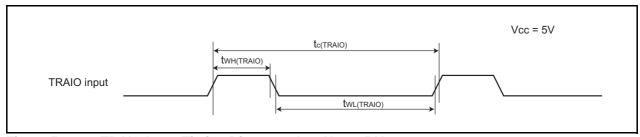


Figure 5.9 TRAIO Input Timing Diagram when Vcc = 5 V

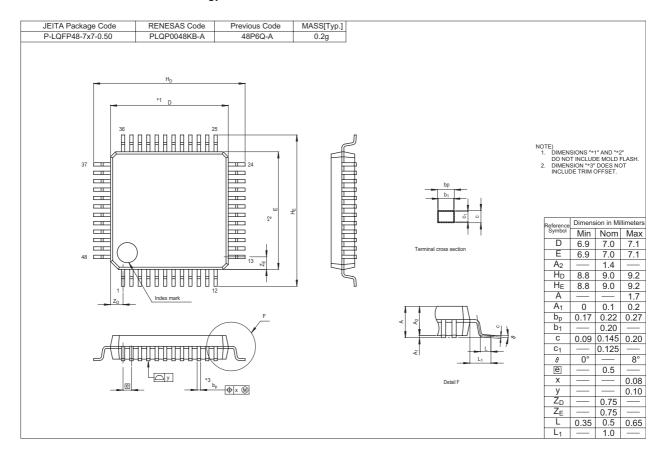
Electrical Characteristics (3) [Vcc = 3 V] **Table 5.20**

Symbol	Parameter		Condition		Standard			Unit
Symbol					Min.	Тур.	Max.	Oill
Vон	Output "H" voltage	Except XOUT	Iон = -1 mA		Vcc - 0.5	=	Vcc	V
		XOUT	Drive capacity HIGH	Iон = -0.1 mA	Vcc - 0.5	_	Vcc	V
			Drive capacity LOW	IOH = -50 μA	Vcc - 0.5	=	Vcc	V
Vol	Output "L" voltage	Except XOUT	IoL = 1 mA		-	-	0.5	V
		XOUT	Drive capacity HIGH	IOL = 0.1 mA	=	=	0.5	V
			Drive capacity LOW	IOL = 50 μA	=	_	0.5	V
VT+-VT-	Hysteresis	NT0, NT1, NT2, NT3, KI0, KI1, KI2, KI3, TRAIO, RXD0, RXD1, CLK0, SSI, SCL, SDA, SSO			0.1	0.3	=	V
		RESET			0.1	0.4	-	V
Іін	Input "H" current		VI = 3 V, Vcc = 3 V		=	=	4.0	μΑ
lıL	Input "L" current		VI = 0 V, Vcc = 3 V		_	-	-4.0	μА
RPULLUP	Pull-up resistance		VI = 0 V, Vcc = 3 V		66	160	500	kΩ
RfXIN	Feedback resistance	XIN			-	3.0	-	MΩ
VRAM	RAM hold voltage		During stop mode		2.0	-	-	V

^{1.} Vcc = 2.7 to 3.3 V at Topr = -40 to 85° C (J version) / -40 to 125° C (K version), f(XIN) = 10 MHz, unless otherwise specified.

Package Dimensions

Diagrams showing the latest package dimensions and mounting information are available in the "Packages" section of the Renesas Technology website.



REVISION HISTORY

R8C/20 Group, R8C/21 Group Datasheet

Day	Date		Description				
Rev.	Date	Page	Summary				
0.10	Mar 08, 2005	_	First Edition issued				
0.20	Sep 29, 2005	-	Words standardized - Clock synchronous serial interface → Clock synchronous serial I/O - Chip-select clock synchronous interface(SSU) → Clock synchronous serial I/O with chip select - I ² C bus interface(IIC) → I ² C bus interface				
		2, 3	Table1.1 R8C/20 Group Performance, Table1.2 R8C/21 Group Performance Serial Interface revised: - Clock Synchronous Serial Interface: 1 channel				
		5, 6	Table 1.3 Product Information of R8C/20 Group, Table 1.4 Product Information of R8C/21 Group Date revised.				
		7	Figure 1.4 Pin Assignment Pin name revised: - P3_5/SSCK(/SCL) \rightarrow P3_5/ SCL/SSCK - P3_4/SCS(/SDA) \rightarrow P3_4/ SDA /SCS - VSS \rightarrow VSS/AVSS - VCC \rightarrow VCC/AVCC - P1_5/RXD0/(TRAIO/INT1) \rightarrow P1_5/RXD0/(TRAIO)/(INT1) - P6_6/INT2/(TXD1) \rightarrow P6_6/INT2/TXD1 - P6_7/INT3/(RXD1) \rightarrow P6_7/INT3/RXD1 - NOTE2 added				
		8	Table 1.5 Pin Description - Analog Power Supply Input: line added - I ² C Bus Interface (IIC) → I ² C Bus Interface - SSU → Clock Synchronous Serial I/O with Chip Select				
		9	Table 1.6 Pin Name Information by Pin Number revised - Pin Number 1: (SCL) → SCL - Pin Number 2: (SDA) → SDA - Pin Number 9: VSS → VSS/AVSS - Pin Number 11: VCC → VCC/AVCC - Pin Number 26: (TXD1) → TXD1 - Pin Number 27: (RXD1) → RXD1				
		15	Table 4.1 SFR Information (1) revised - 0013h: XXXXXX00b → 00h				
		17	Table 4.3 SFR Information (3) revised - 00BCh: 0000X000b → 00h/0000X000b				
		18	Table 4.4 SFR Information (4) revised - 00D6h: 00000XXXb → 00h - 00F5h: UART1 Function Select Register added				
		19	Table 4.5 SFR Information (5) revised - 0104h: TRATR → TRA				